

**DEPARTMENT OF ELECTRICAL ENGINEERING  
INDIAN INSTITUTE OF TECHNOLOGY, KANPUR**

Enquiry No.: EE/IITK/ARH/2015-16/001

Opening Date: August 17, 2015

Closing Date: August 31, 2015

Extend Date: September 10, 2015

**Subject: Purchase of Double sided copper clad dielectric substrate**

We are looking to procure Double sided copper clad dielectric substrate with following specifications:

Sl. No.	Item	Permittivity	Thickness (in mil)	Copper Cladding	Loss Tangent (Maximum)	Size	Qty.
1.	Double sided copper clad dielectric substrate	4.5	60	1Oz. On each side	0.0035	18" x 12"	02 Sheets
2.	Double sided copper clad dielectric substrate	6	60	1Oz. On each side	0.003	18" x 12"	02 Sheets
3.	Double sided copper clad dielectric substrate	10.2	60	1Oz. On each side	0.0035	18" x 12"	02 Sheets

**Terms & Condition:**

1. Along with the quotation please include an Authorization Letter from manufacturer.
2. All quotation in sealed envelope must reach the undersigned on or before **August 31, 2015.**
3. Quotation must be valid for 60 days.
4. Delivery period should not to be more than 08 weeks.
5. Please include complete technical specification of the product.

Sincerely yours,

**A. R. Harish**

Professor

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